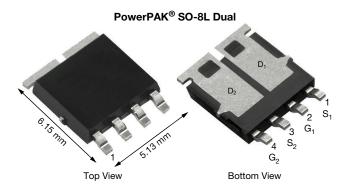
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 D_2

Automotive Dual N-Channel 80 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY	
V _{DS} (V)	80
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0215
I _D (A) per leg	30
Configuration	Dual
Package	PowerPAK SO-8L

FEATURES

• TrenchFET[®] power MOSFET

D1

- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



RoHS COMPLIANT HALOGEN FREE

80 0215 30 Dual AK SC)-8L	G ₁ O		
(T _C =	25 °C, ur	less otherwise noted)		
		SYMBOL	LIMIT	UNIT
		V _{DS}	80	V
		V _{GS}	± 20	v
	T 05 00	2	88	

ABSOLUTE MAXIMUM RATING	iS (T _C = 25 °C, unless	s otherwise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage Gate-Source Voltage		V _{DS}	80	v	
		V _{GS}	± 20		
Continuous Drain Current	$T_C = 25 \ ^{\circ}C \ ^{a}$	Ŀ	30		
Continuous Drain Current	T _C = 125 °C	Ι _D	18		
Continuous Source Current (Diode conduction) ^a		I _S	30	А	
Pulsed Drain Current ^b		I _{DM}	80		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	22		
Single Pulse Avalanche Energy	L = 0.1 mm	E _{AS}	24	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	= 25 °C 48		W	
	T _C = 125 °C	P _D	16	vv	
Operating Junction and Storage Temperatu	re Range	T _J , T _{stg}	-55 to +175	°C	
Soldering Recommendations (Peak temperations)	ature) ^{d, e}		260	U	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB mount ^c	R _{thJA}	85	°C/W
Junction-to-Case (Drain)		R _{thJC}	3.1	0/10

Notes

a. Package limited.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

c. When mounted on 1" square PCB (FR4 material).

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

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SPECIFICATIONS (T _C = 25 $^{\circ}$ C,	unless otherv	vise noted)					
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	80	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.5	3.0	3.5	v
Gate-Source Leakage	I _{GSS}	V _{DS} =	0 V, $V_{GS} = \pm 20$ V	-	-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = 80 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 80 V, T _J = 125 °C	-	-	50	μA
		$V_{GS} = 0 V$	V _{DS} = 80 V, T _J = 175 °C	-	-	150	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	25	-	-	А
		$V_{GS} = 10 V$	I _D = 10 A	-	0.0179	0.0215	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V}$	I _D = 10 A, T _J = 125 °C	-	-	0.0353	μΑ
		$V_{GS} = 10 V$	I _D = 10 A, T _J = 175 °C	-	-	0.0439	
Forward Transconductance b	9 _{fs}	V _{DS} = 15 V, I _D = 10 A		-	24	-	S
Dynamic ^b							
Input Capacitance	C _{iss}			-	875	1200	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$	V _{DS} = 25 V, f = 1 MHz	-	445	600	pF
Reverse Transfer Capacitance	C _{rss}]		-	25	35	
Total Gate Charge ^c	Qg			-	14	25	
Gate-Source Charge ^c	Q _{gs}	$V_{GS} = 10 V$	$V_{DS} = 40 \text{ V}, \text{ I}_{D} = 1.5 \text{ A}$	-	4	-	nC
Gate-Drain Charge ^c	Q _{gd}]		-	3	-	
Gate Resistance	R _g	f = 1 MHz		0.18	0.41	0.65	Ω
Turn-On Delay Time ^c	t _{d(on)}			-	13	25	
Rise Time ^c	tr	V _{DD} =	$V_{DD} = 40 \text{ V}, \text{ R}_{\text{I}} = 26.7 \Omega$		3	10	ns
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \simeq 1.5$ A, $V_{GEN} = 10$ V, $R_g = 1 \Omega$		-	21	40	
Fall Time ^c	t _f	1		-	22	40	
Source-Drain Diode Ratings and Chara	cteristics ^b						
Pulsed Current ^a	I _{SM}			-	-	80	Α

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

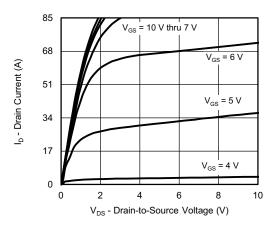
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

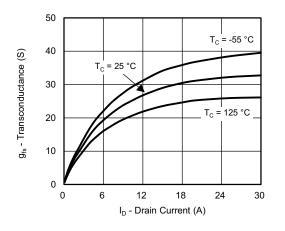
2



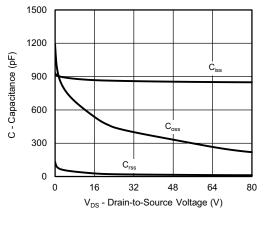
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



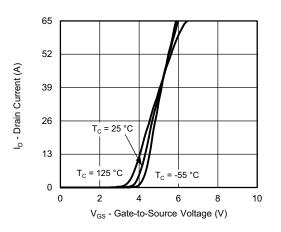
Output Characteristics



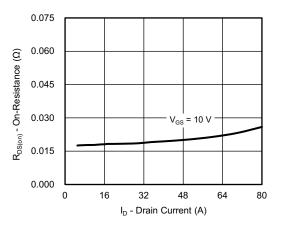
Transconductance



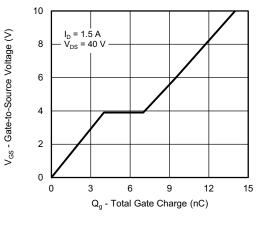
Capacitance



Transfer Characteristics



On-Resistance vs. Drain Current



Gate Charge

S16-1733-Rev. A, 29-Aug-16

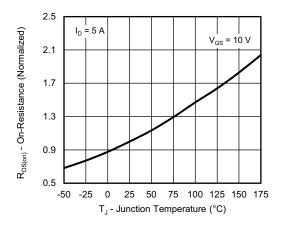
3

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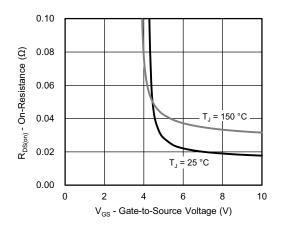
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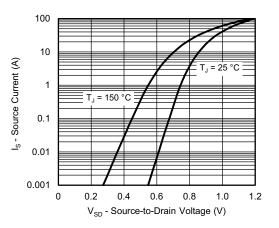
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



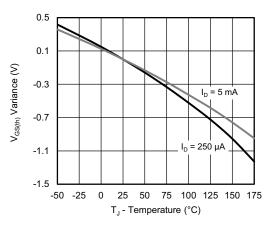
On-Resistance vs. Junction Temperature



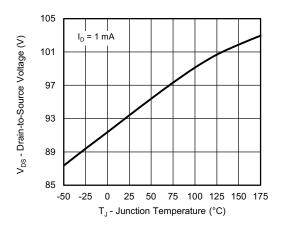
On-Resistance vs. Gate-to-Source Voltage



Source Drain Diode Forward Voltage







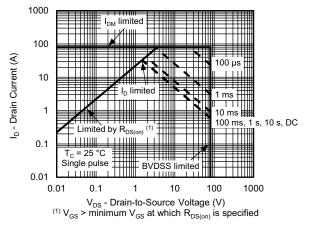
Drain Source Breakdown vs. Junction Temperature



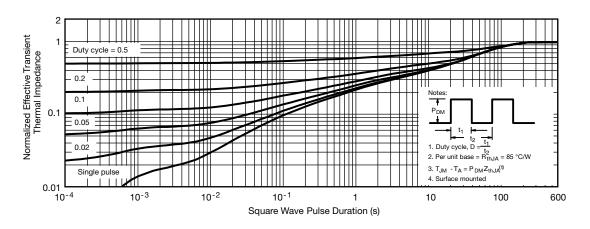
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THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

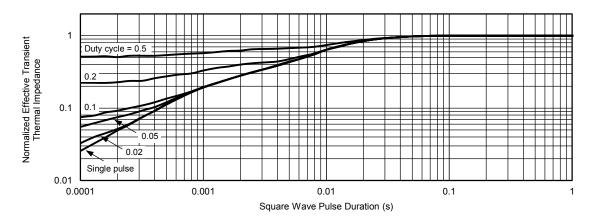


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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

The characteristics shown in the two graphs

S16-1733-Rev. A, 29-Aug-16

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?75045.









Package Information



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DIM.	MILLIMETERS			INCHES				
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX		
А	1.00	1.07	1.14	0.039	0.042	0.045		
A1	0.00	-	0.127	0.00	-	0.005		
b	0.33	0.41	0.48	0.013	0.016	0.019		
b1	0.44	0.51	0.58	0.017	0.020	0.023		
b2	4.80	4.90	5.00	0.189	0.193	0.197		
b3		0.094			0.004			
b4		0.47			0.019			
С	0.20	0.25	0.30	0.008	0.010	0.012		
D	5.00	5.13	5.25	0.197	0.202	0.207		
D1	4.80	4.90	5.00	0.189	0.193	0.197		
D2	3.86	3.96	4.06	0.152	0.156	0.160		
D3	1.63	1.73	1.83	0.064	0.068	0.072		
е		1.27 BSC			0.050 BSC			
E	6.05	6.15	6.25	0.238	0.242	0.246		
E1	4.27	4.37	4.47	0.168	0.172	0.176		
E2	2.75	2.85	2.95	0.108	0.112	0.116		
E3	6.05	6.22	6.40	0.238	0.245	0.252		
F	-	-	0.15	-	-	0.006		
L	0.62	0.72	0.82	0.024	0.028	0.032		
L1	0.92	1.07	1.22	0.036	0.042	0.048		
К		0.51		0.020				
W		0.23		0.009				
W1	0.41			0.016				
W2		2.82			0.111			
W3		2.96		0.117				
θ	0°	-	10°	0°	-	10°		

Note

• Millimeters will govern



RECOMMENDED MINIMUM PAD FOR PowerPAK® SO-8L DUAL



Recommended Minimum Pads Dimensions in mm (inches) Keep-out 6.75 (0.266) x 7.75 (0.305)

Revision: 07-Feb-12



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